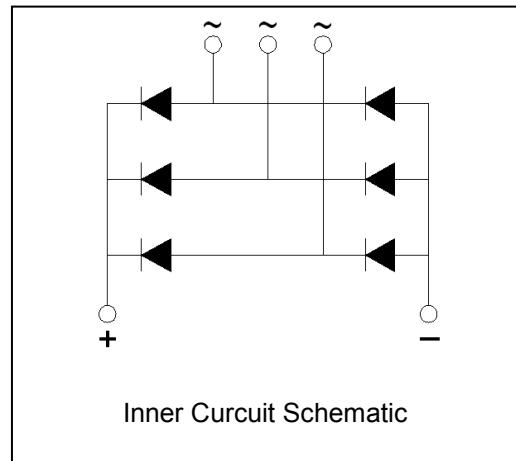


**PHD****DPC250A 1K6V...SERIES****THREE PHASE BRIDGE**

3-Phase Rectifier Series

**Features**

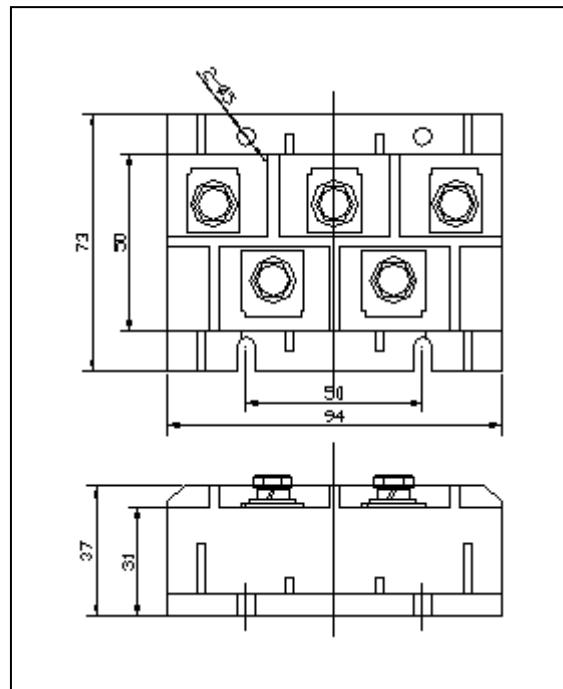
- Low  $V_F$
- Direct Mounting to heatsink
- Low profile package
- Glass Passivation Chip
- Easy Connection
- Insulated Type

**Typical Applications**

- Inverters
- Welding
- UPS
- SMPS
- Battery Chargers
- DC Motors
- General Purpose DC Power Supplies

**Major Ratings and Characteristics**

Parameters	DPC250A 1K6V	Units
$I_o$	250	A
@ $T_c$	105	°C
$I_{FSM}$	400	A
@ 50Hz	620	A
@ 60Hz		
$I^2 t$	1370	$A^2 s$
@ 50Hz	1230	$A^2 s$
$V_{DRM}/V_{RRM}$	1600	V
$T_j$ range	- 40 to 150	°C



**ELECTRICAL SPECIFICATIONS****Voltage Ratings**

Type number	Voltage Code	$V_{RRM}/V_{DRM}$ , maximum repetitive peak reverse voltage V	$V_{RSM}$ , maximum non- repetitive peak rev. voltage V	$I_{RRM}/I_{DRM}$ max. @ $T_J = T_{J\max}$ mA
DPC250A.	04	400	500	5
	08	800	900	
	12	1200	1300	
	14	1400	1500	
	16	1600	1700	

**Forward Conduction**

Parameter	DPC250A	Units	Conditions					
$I_o$ Maximum DC output current @ Case temperature	250	A	120° Rect conduction angle					
	105	°C						
$I_{FSM}$ , Maximum peak, one-cycle forward, non-repetitive on state surge current	400	A	t = 10ms	No voltage reapplied	Initia $T_J = T_{J\max}$			
	620		t = 8.3ms					
	430		t = 10ms	100% $V_{RRM}$ reapplied				
	460		t = 8.3ms					
$I^2 t$ Maximum $I^2 t$ for fusing	1370	A <sup>2</sup> s	t = 10ms	No voltage reapplied				
	1230		t = 8.3ms					
	620		t = 10ms	100% $V_{RRM}$ reapplied				
	690		t = 8.3ms					
$I^2 \sqrt{t}$ Maximum $I^2 \sqrt{t}$ for fusing	15100	$A^2 \sqrt{s}$	t = 0.1 to 10ms, no voltage reapplied					
$V_{FM}$ Maximum forward voltage drop	1.25	V	$V_{FM} = 1.25$ V at $I_o = 250$ mA, $T_J = 25^\circ C$ , $t_p = 400 \mu s$ single junction					

**Insulation Table**

Parameter	DPC250A	Units	Conditions	
$V_{INS}$ RMS insulation voltage	2500	V	$T = 25^\circ C$ all terminal shorted	$f = 50Hz, t = 1s$

## Thermal and Mechanical Specifications

Parameter	DPC250A	Units	Conditions
T <sub>J</sub>	Maximum junction operating temperature range	- 40 to 150	°C
T <sub>stg</sub>	Maximum storage temperature range	- 40 to 150	°C
R <sub>thJC</sub>	Maximum thermal resistance, junction to case	0.1	DC operation per module
		1.0	DC operation per junction
		0.12	120° Rect conduction angle per module
		1. 0	120° Rect conduction angle per junction
R <sub>thJC</sub>	Maximum I <sup>2</sup> √ t for fusing	0.10	K/W Per module. Mounting surface smooth, flat and greased. Heatsink compound thermal conductivity = 0.42W/mK
T	Mounting torque ± 10% to heatsink	3	Nm A mounting compound is recommended and the torque should be rechecked after a period of 3 hours to allow for the spread of the compound.Lubricated threads.
wt	Approximate weight	458	g

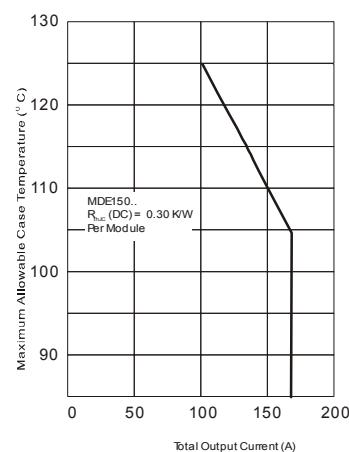
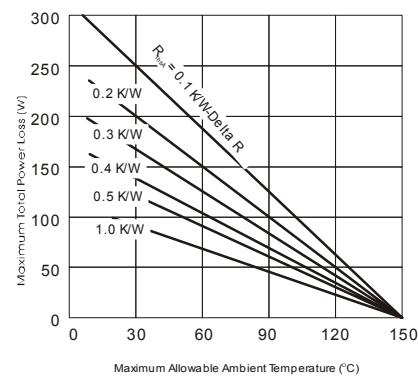
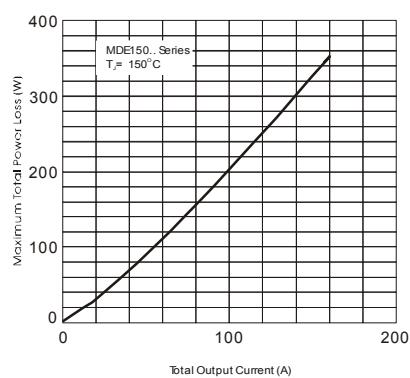


Fig. 1 - Current Rating Characteristics



**Outline Table**